



1.36-W Mono Fully Differential Audio Power Amplifier

DESCRIPTION

The EUA6204C is a mono fully-differential audio amplifier, capable of delivering 1.36W of continuous average power to an $\$\Omega$ BTL load with less than 1% distortion (THD+N) from a 5V power supply, and 720mW to an $\$\Omega$ load from a 3.6V power supply.

The EUA6204C is ideal for PDA/smart phone application due to features such as -80-dB supply voltage rejection from 20Hz to 20kHz, improved RF rectification immunity, small 20mm² PCB area, and a fast startup with minimal pop.

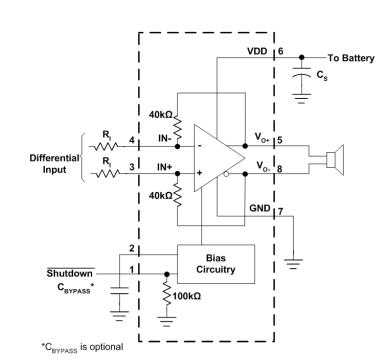
The EUA6204C is available in a MSOP-8 and in the space-saving $3mm \times 3mm$ DFN package.

FEATURES

- Supply Voltage 2.5V to 5.5V
- 1.36W into 8Ω from a 5-V Supply at THD=1% (typ)
- Low Supply Current: 4mA typ at 5V
- Shutdown Current: 0.01µA typ
- Fast Startup with Minimal Pop
- Only Three External Components
 - Improved PSRR (-80dB) for Direct Battery Operation
 - Full Differential Design Reduces RF Rectification
 - 63dB CMRR Eliminates Two Input Coupling Capacitors
- RoHS Compliant and 100% Lead (Pb)-Free

APPLICATIONS

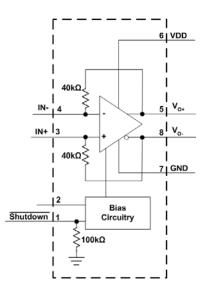
- Wireless Handsets
- PDAs
- Portable Devices



Typical Application Circuit



Block Diagram



Pin Configurations

Package	Pin Configurations
TDFN-8	Shutdown 1 8 Vo. Bypass 2 7 GND IN+ 3 6 Vob IN- 4 5 Vo+
MSOP-8	Shutdown18 $V_{O.}$ Bypass27GNDIN+36 V_{DD} IN-45 V_{O+}

Pin Description

SYMBOL	PIN	DESCRIPTION		
Shutdown	1	Shutdown terminal		
Bypass	2	Mid-supply voltage, adding a bypass capacitor improves PSRR		
IN+	3	Positive differential input		
IN-	4	Negative differential input		
VO+	5	Positive BTL output		
VDD	6	Power supply		
GND	7	High-current ground		
VO-	8	Negative BTL output		



EUA6204C

Ordering Information

Order Number	Package Type	Marking	Operating Temperature Range
EUA6204CJIR1	TDFN-8	xxxxx 6204C	-40°C to 85°C
EUA6204CMIR1	MSOP-8	xxxxx 6204C	-40°C to 85°C

EUA6204C	
	Lead Free Code 1: Lead Free 0: Lead
	Packing R: Tape & Reel
	Operating temperature range I: Industry Standard
	Package Type J: TDFN M: MSOP



Absolute Maximum Ratings

• Supply voltage, V _{DD} 6V
• Input voltage, V_1
• Storage temperature rang, T _{stg}
• ESD Susceptibility 2kV
Junction Temperature 150°C
Thermal Resistance
θ _{JC} (MSOP) 53°C/W
θ _{JA} (MSOP) 159°C/W
θ _{JC} (TDFN) 3.2°C/W
θ _{JA} (TDFN) 39.1°C/W

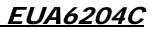
Recommended Operating Conditions

	MIN	NOM MAX	UNIT
Supply Voltage, V _{DD}	2.5	5.5	V
High-level input voltage, V _{IH}	1.55		V
Low-level input voltage, V _{IL}		0.5	
Operating free-air temperature, T _A	-40	85	°C

Electrical Characteristics, $T_A{=}25^\circ C$

	abol Parameter Conditions		E	UA620	4C	Unit
Symbol			Min	Тур	Max.	Unit
V _{OS}	Output offset voltage (measured differentially)	V _I =0V differential, Gain=1V/V, V _{DD} =5.5V	-9	2	9	mV
PSRR	Power supply rejection ratio	V_{DD} =2.5V to 5.5V		-85	-60	dB
V _{IC}	Common mode input range	V _{DD} =2.5V to 5.5V	0.5		V _{DD} -0.8	V
CMRR	Common mode rejection	V_{DD} =2.5V, V_{IC} =0.5V to 1.7V		-63	-40	dB
CIVIKK	range	V_{DD} =5.5V, V_{IC} =0.5V to 4.7V		-63	-40	uD
		$R_L=8\Omega$, $Gain=1V/V$ $V_{DD}=5.5V$		0.45		
	Low-output swing	$V_{IN+}=V_{DD}$, $V_{IN}=0V$ or $V_{DD}=3.6V$		0.37		V
		$V_{IN+}=0V$, $V_{IN}=V_{DD}$ $V_{DD}=2.5V$		0.26	0.4	
		$R_L=8\Omega$, $Gain=1V/V$ $V_{DD}=5.5V$		4.95		
	High-output swing	$V_{IN+}=V_{DD}$, $V_{IN}=0V$ or $V_{DD}=3.6V$		3.18		V
		$V_{IN}=V_{DD}, V_{IN}=0V V_{DD}=2.5V$	2	2.13		
$ \mathbf{I}_{\mathrm{IH}} $	High-level input current, Shutdown	V _{DD} =5.5V, V _I =5.8V		58	100	μΑ
$ \mathbf{I}_{\mathrm{IL}} $	Low-level input current, Shutdown	V_{DD} =5.5V, V_{I} =-0.3V		3	100	μΑ
I _Q	Quiescent current	V _{DD} =2.5V to 5.5V, no load		4	8	mA
I _(SD)	Supply current	V($\overline{\text{Shutdown}}$) ≤ 0.5 V, V _{DD} =2.5V to 5.5V, R _L = 8Ω		0.01	1	μΑ
	Gain	$R_L = 8\Omega$	<u>38kΩ</u> RI	<u>40kΩ</u> RI	<u>42kΩ</u> RI	V/V
	Resistance from shutdown to GND			100		kΩ



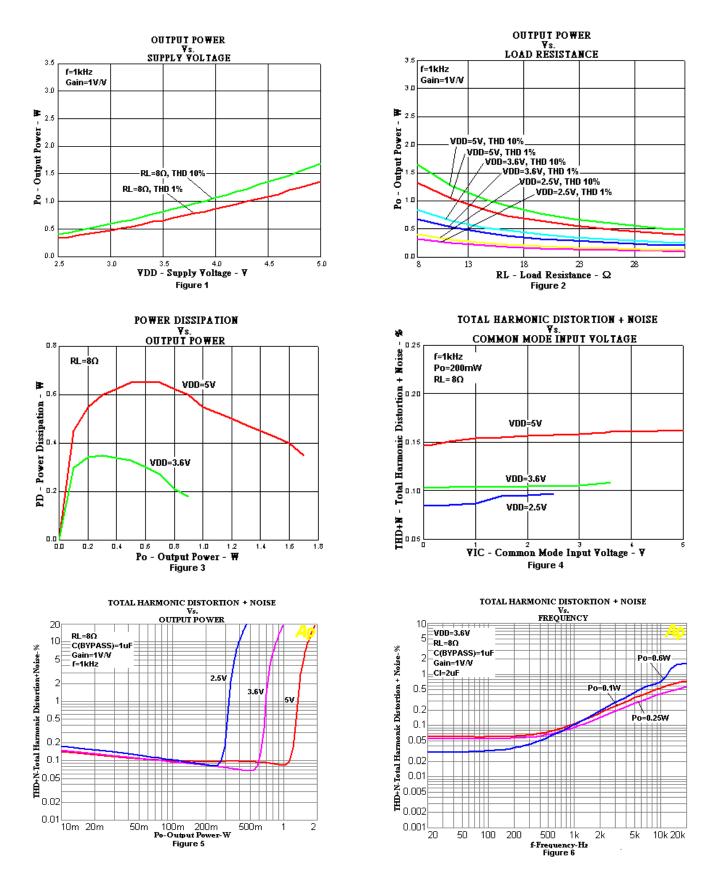


Operating Characteristics, T_A=25°C, Gain=1V/V

			EUA6204C					
Symbol	Parameter	Conditions		Min Ty	Тур	Max.	Unit	
			V _{DD} =5V		1.36		W	
		THD+N=1%, f=1kHz,R _L =8 Ω	V _{DD} =3.6V		0.72			
Po	Output power		V _{DD} =2.5V		0.33			
10			V _{DD} =5V		1.7			
		THD+N=10%, f=1kHz,R _L =8 Ω	V _{DD} =3.6V		0.85		W	
			$V_{DD}=2.5V$		0.4			
		$V_{DD}=5V$, $P_O=1W$, $R_L=8\Omega$, $f=1kI$	Hz		0.15			
THD+N	Total harmonic distortion plus noise	V_{DD} =3.6V, P_0 =0.5W, R_L =8 Ω , f=		0.1		%		
	plus noise	V_{DD} =2.5V, P_0 =200mW, R_L =8 Ω , f=1kHz			0.1			
	Supply ripple rejection	V _{DD} =3.6V, Inputs ac-grounded	f=217Hz		-77			
K _{SVR}	ratio	with $C_i=2\mu F$, $V_{(Ripple)}=200 mVpp$	f=20Hz to 20kHz		-60		dB	
SNR	Signal-to-noise ratio	V_{DD} =5V, P_0 =1W, R_L =8 Ω			100		dB	
Vn	Output voltage noise	V _{DD} =3.6V, f=20Hz to 20kHz, Inputs ac-grounded with	No weighting		25			
VII		$C_i=2\mu F$	A weighting		19		μV _{RMS}	
CMRR	Common mode rejection ratio	V_{DD} =3.6V V_{IC} =1Vpp f=217Hz			-64		dB	
$R_{\rm F}$	Feedback resistance			38	40	44	kΩ	
	Start-up time from shutdown	V _{DD} =3.6V, C _{BYPASS} =0.1µF			27		ms	



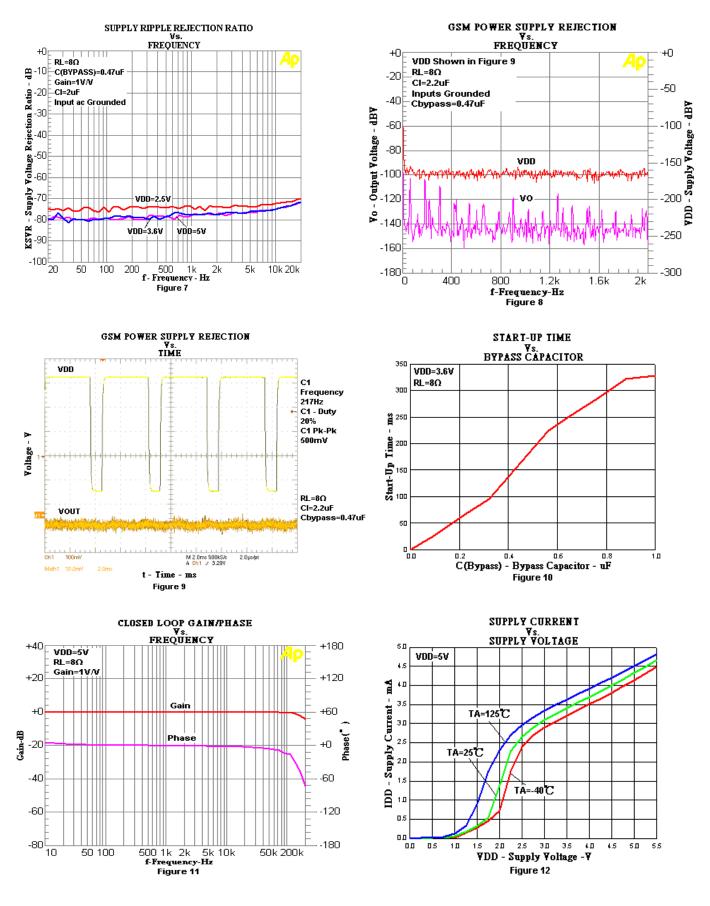
Typical Operating Characteristics



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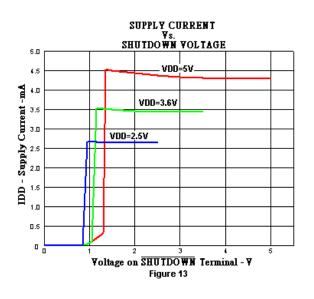






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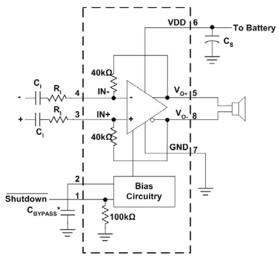
Application Information

Application Schematics

Figure14 through Figure15 show application schematics for differential and single-ended inputs. Typical values are shown in Table1.

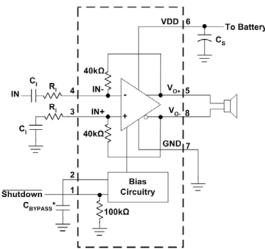
Table1.	Typical	Component	Value
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Component	Value
R _I	40kΩ
C _(BYPASS)	0.22µF
Cs	1µF
CI	0.22µF



*C_{BYPASS} is optional

Figure14. Differential Input Application Schematic Optimized with Input Capacitors



*C_{BYPASS} is optional

** Due to the fully differential design of this amplifier, the performance is severly degraded if you connect the unused input to BYPASS when using single-ended inputs

Figure15. Single-Ended Input Application Schematic

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Power Dissipation

Power dissipation is a major concern when designing a successful amplifier, whether the amplifier is bridged or single-ended. A direct consequence of the increased power delivered to the load by a bridge amplifier is an increase in internal power dissipation. Since the EUA6204C has two operational amplifiers in one package, the maximum internal power dissipation is 4 times that of a single-ended amplifier. The maximum power dissipation for a given application can be derived from the power dissipation graphs of from equation1.

$$P_{DMAX} = 4 * (V_{DD})^2 / (2\pi^2 R_L)$$
------(1)

It is critical that the maximum junction temperature T_{JMAX} of 150°C is not exceeded. T_{JMAX} can be determine from the power derating curves by using P_{DMAX} and the PC board foil area. By adding additional copper foil, the thermal resistance of the application can be reduced, resulting in higher P_{DMAX} . Additional copper foil can be added to any of the leads connected to the EUA6204C. If T_{JMAX} still exceeds 150°C, then additional changes must be made. These changes can include reduced supply voltage, higher load impedance, or reduced ambient temperature. Internal power dissipation is a function of output power.

Proper Selection of External Components

Gain-Setting Resistor Selection

The input resistor (R_I) can be selected to set the gain of the amplifier according to equation 2.

$$Gain=R_{\rm F}/R_{\rm I} \tag{2}$$

The internal feedback resistors (R_F) are trimmed to 40k Ω .

Resistor matching is very important in fully differential amplifiers. The balance of the output on the reference voltage depends on matched ratios of the resistors. CMRR, PSRR, and the cancellation of the second harmonic distortion diminishes if resistor mismatch occurs. Therefore, it is recommended to use 1% tolerance resistors or better to keep the performance optimized.

Bypass Capacitor (C_{BYPASS}) and Start-up Time

The internal voltage divider at the Bypass pin of this device sets a mid-supply voltage for internal references and sets the output common mode voltage to $V_{DD}/2$. Adding a capacitor to this pin filters any noise into this pin and increases k_{SVR} . $C_{(BYPASS)}$ also determines the rise time of V_{O^+} and V_{O^-} when the device is taken out of shutdown. The larger the capacitor, the slower the rise time. Show the relationship of $C_{(BYPASS)}$ to start-up time as Figure10.

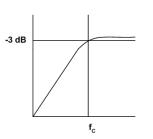


Input Capacitor (C_I)

The EUA6204C does not require input coupling capacitors if using a differential input source that is biased from 0.5V to V_{DD} -0.8V. Use 1% tolerance or better gain-setting resistors if not using input coupling capacitors.

In the single-ended input application an input capacitor, C_I , is required to allow the amplifier to bias the input signal to the proper dc level. In this case, C_I and R_I form a high-pass filter with the corner frequency determined in equation3.

$$f_{C} = \frac{1}{2\pi R C}$$
(3)



The value of C_I is important to consider as it directly affects the bass (low frequency) performance of the circuit.

Consider the example where R_I is $10k\Omega$ and the specification calls for a flat bass response down to 100Hz. Equation 3 is reconfigured as equation4.

$$C_{I} = \frac{1}{2\pi R_{I} f_{C}}$$
(4)

In this example, C_I is 0.16µF, so one would likely choose a value in the range of 0.22µF to 0.47µF.

Ceramic capacitors should be used when possible, as they are the best choice in preventing leakage current. When polarized capacitors are used, the positive side of the capacitor should face the amplifier input in most applications, as the dc level there is held at $V_{DD}/2$, which is likely higher than the source dc level. It is important to confirm the capacitor polarity in the application.

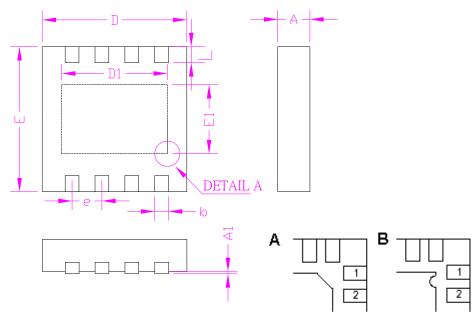
Decoupling Capacitor (Cs)

The EUA6204C is a high-performance CMOS audio amplifier that requires adequate power supply decoupling to ensure the output total harmonic distortion (THD) is as low as possible. Power supply decoupling also prevents oscillations for long lead lengths between the amplifier and the speaker. For higher frequency transients, spikes, or digital hash on the line, a good low equivalent-series-resistance (ESR) ceramic capacitor, typically 0.1μ F to 1μ F, placed as close as possible to the device V_{DD} lead works best. For filtering lower frequency noise signals, a $10-\mu$ F or greater capacitor placed near the audio power amplifier also helps, but is not required in most applications because of the high PSRR of this device.



Package Information

TDFN-8

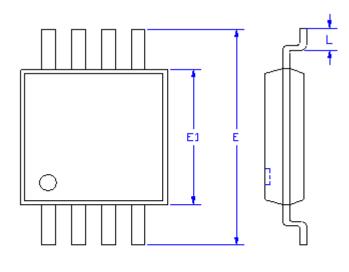


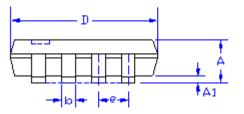
DETAIL A Thermal Pad Option

SYMBOLS	MILLIMETERS		INCHES		
STNDOLS	MIN.	MAX.	MIN.	MAX.	
А	0.70	0.80	0.028	0.031	
A1	0.00	0.05	0.000	0.002	
b	0.20	0.40	0.008	0.016	
D	2.90	3.10	0.114	0.122	
D1	2.3	0	0.090		
E	2.90	3.10	0.114	0.122	
E1	1.50 0.059		1.50 0		59
е	0.65		0.02	26	
L	0.25	0.45	0.010	0.018	









SYMBOLS	MILLIMETERS		INCHES		
51 MIDOL5	MIN.	MAX.	MIN.	MAX.	
А	-	1.10	-	0.043	
A1	0.00	0.15	0.000	0.006	
D	3.00		0.118		
E1	3.00		0.118		
Е	4.70	5.10	0.185	0.201	
L	0.40	0.80	0.016	0.031	
b	0.22	0.38	0.008	0.015	
e	0.65		0.02	26	

